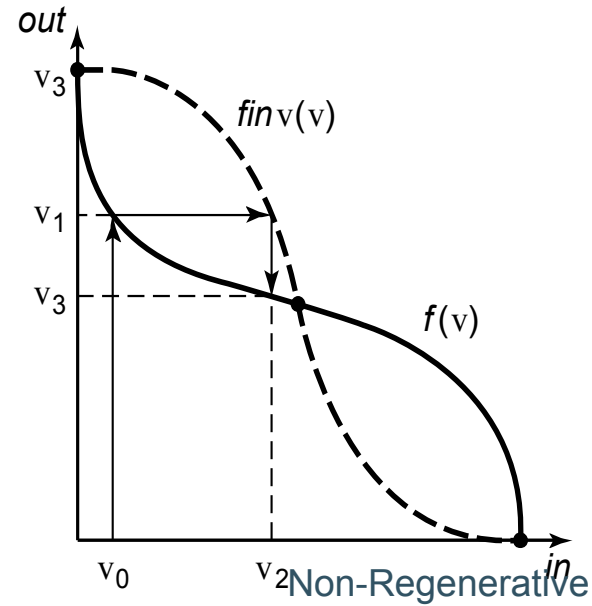
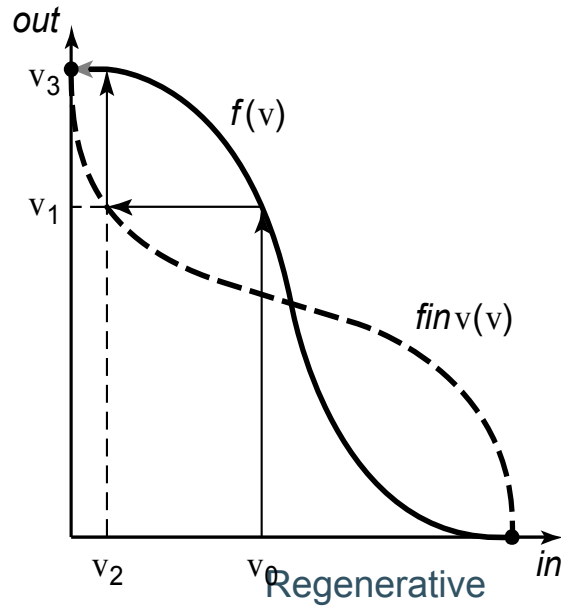
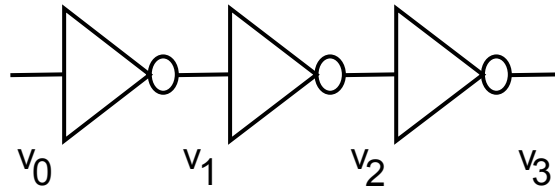


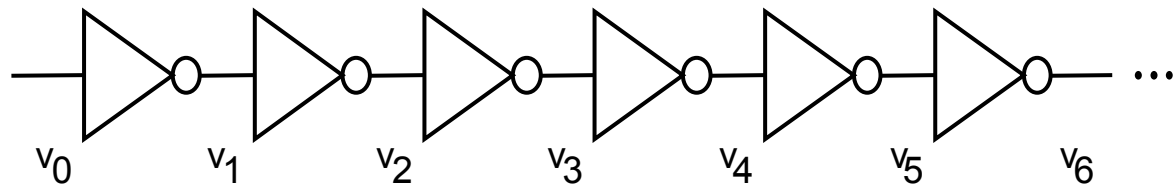
# CHARACTERISTICS OF DIGITAL ICs

## Regenerative Property

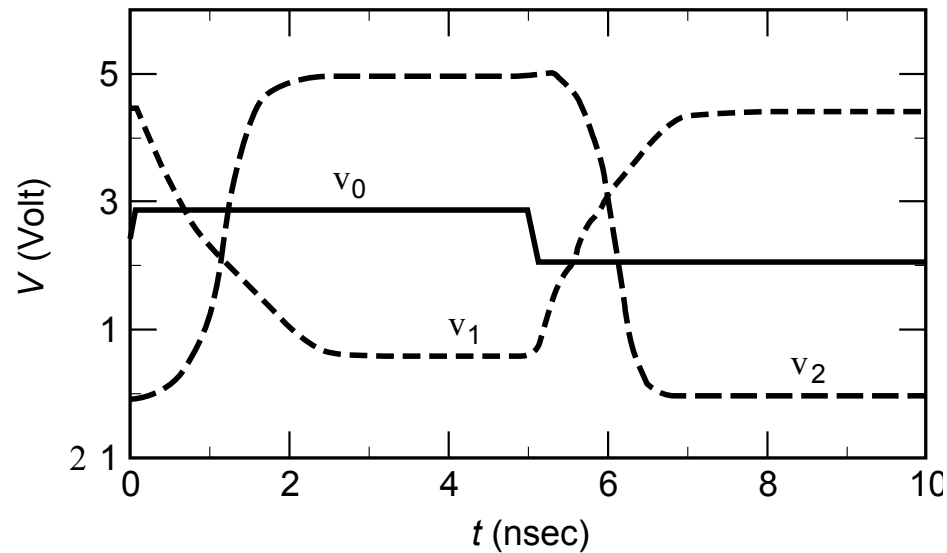


## CHARACTERISTICS OF DIGITAL ICs

# Effect of Regenerative Property



A chain of inverters



Simulated response

## CHARACTERISTICS OF DIGITAL ICs

# Key Reliability Properties

- Absolute noise margin values are deceptive
  - A floating node is more easily disturbed than a node driven by a low impedance (in terms of voltage)
- Noise immunity is the most important metric
  - Defines the circuit capability to suppress noise sources
- Key metrics:
  - Noise transfer functions
  - Output impedance of the driver
  - Input impedance of the receiver

# Noise Budget

- Allocates gross noise margin to expected sources of noise
- Differentiate between fixed ( $V_{Nf}$ ) and proportional ( $V_{sw}$ ) noise sources

$$V_{NM} = \frac{V_{sw}}{2} \geq \sum_i f_i V_{Nfi} + \sum_j g_j V_{sw}$$

- Sources: supply noise, cross talk, interference, offset

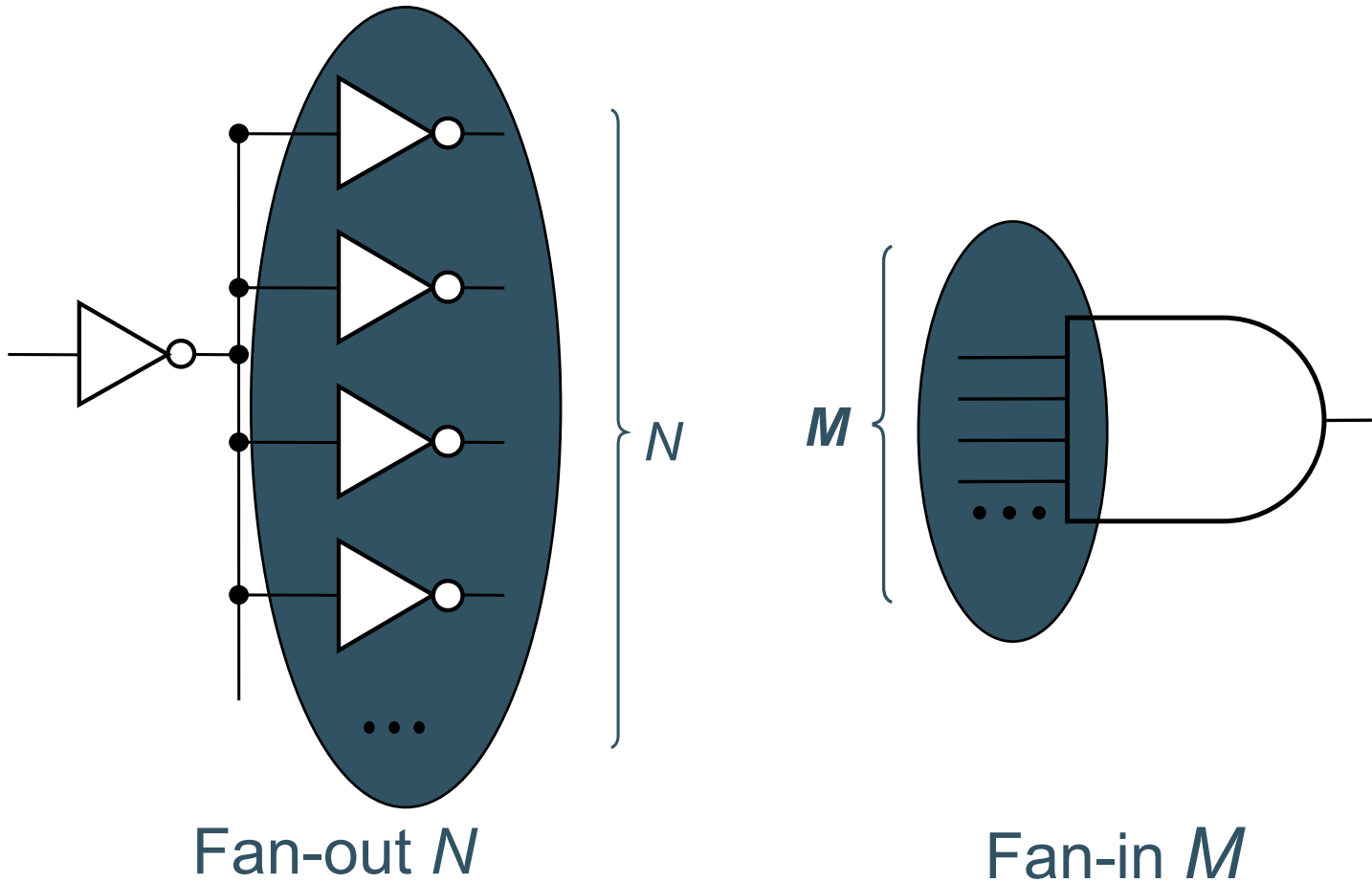
## CHARACTERISTICS OF DIGITAL ICs

# Directivity

- Digital gates are expected to be Unidirectional
  - Changes in the output should not affect the signals at the input
- Fully directivity cannot be achieved
  - Feedback
  - Coupling

# CHARACTERISTICS OF DIGITAL ICs

## Fan-in and Fan-out



# Fan-out Criteria

- Fan-Out Definition:

Maximum number of loads (N) that a gate can handle without degrading its functionality or performance.

- Current-voltage criteria

$$N = \min \left\{ \left| \frac{I_{OH}}{I_{IH}} \right|, \left| \frac{I_{OL}}{I_{IL}} \right| \right\}$$

- Performance criteria

$$N = \min \left\{ \left| \frac{C_{LH \max}}{C_{in}} \right|, \left| \frac{C_{HL \max}}{C_{in}} \right| \right\}$$

## CHARACTERISTICS OF DIGITAL ICs

# Power Dissipation

Instantaneous power:

$$p(t) = v(t)i(t) = V_{supply}i(t)$$

Peak power:

$$P_{peak} = V_{supply}i_{peak}$$

Average power:

$$P_{ave} = \frac{1}{T} \int_t^{t+T} p(t)dt = \frac{V_{supply}}{T} \int_t^{t+T} i_{supply}(t)dt$$



CHARACTERISTICS OF DIGITAL ICs

# Power Components

$$P_T = P_S + P_D$$

- Static Power ( $P_S$ ):
  - Consumed to hold a static logic level
- Dynamic Power ( $P_D$ ):
  - Associated to level transitions on the gate

## CHARACTERISTICS OF DIGITAL ICs

# Energy and Energy-Delay

Power-Delay Product (PDP) =

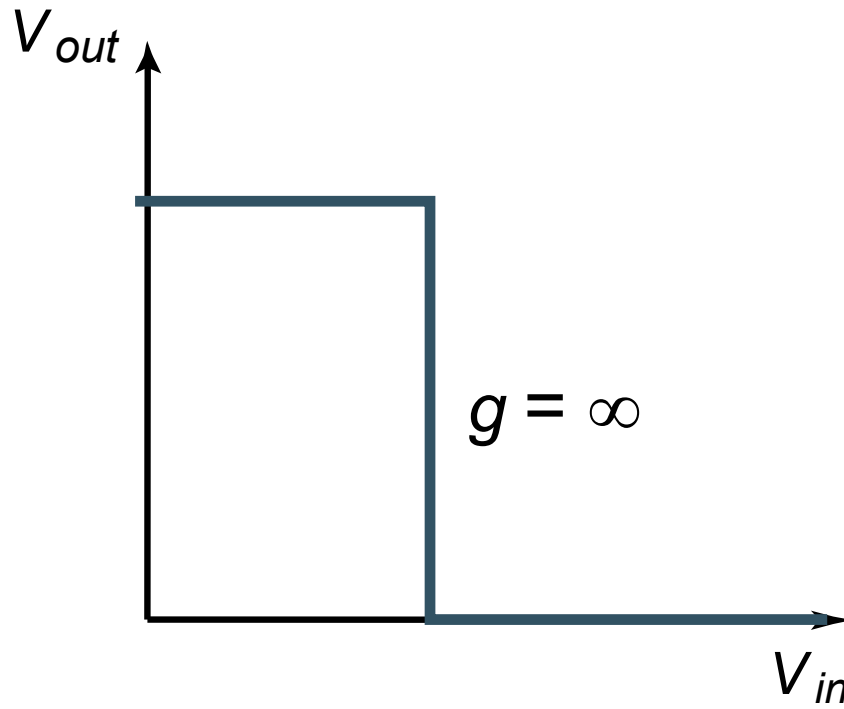
$$E = \text{Energy per operation} = P_{av} \times t_p$$

Energy-Delay Product (EDP) =

$$\text{quality metric of gate} = E \times t_p$$

## CHARACTERISTICS OF DIGITAL ICs

# The Ideal Gate



$$Z_i = \infty$$

$$Z_o = 0$$

$$N = \infty$$

$$LS = V_{DD} - V_{SS}$$

$$NM_H = NM_L = \frac{V_{swing}}{2}$$

$$t_{PD} = 0$$

$$P_D = 0$$